

# Part Number: XZMYKVG56WT-5

3.0mmx1.0mm RIGHT ANGLE SMD CHIP LED LAMP

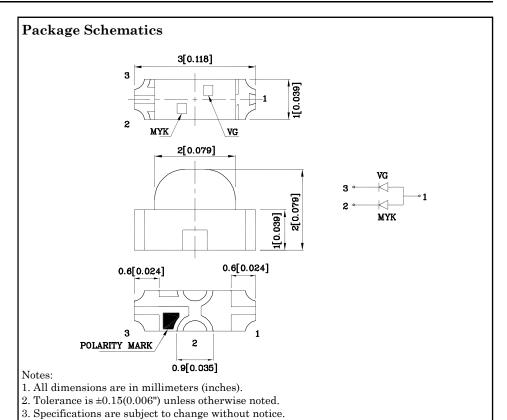


# **Features**

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- ullet Package : 2000 pcs / reel
- Moisture sensitivity level : level 3
- RoHS compliant







Absolute Maximum Ratings $(T_A=25^{\circ}C)$		MYK (AlGaInP)	VG (AlGaInP)	Unit
Reverse Voltage	$V_{\mathrm{R}}$	5	5	V
Forward Current	$I_{\mathrm{F}}$	30	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i <sub>FS</sub>	175	150	mA
Power Dissipation	$P_D$	75	75	mW
Operating Temperature	$T_{A}$	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~ +85		

Operating Characteristics (T <sub>A</sub> =25°C)		MYK (AlGaInP)	VG (AlGaInP)	Unit
Forward Voltage (Typ.) $(I_F=20\text{mA})$	$V_{\mathrm{F}}$	2	2.1	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	2.5	V
Reverse Current (Max.) $(V_R=5V)$	$I_R$	10	10	uA
Wavelength of Peak Emission (Typ.) (I <sub>F</sub> =20mA)	λΡ	590	574	nm
Wavelength of Dominant Emission (Typ.) (I <sub>F</sub> =20mA)	λD	590	570	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	Δλ	20	20	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	20	15	pF

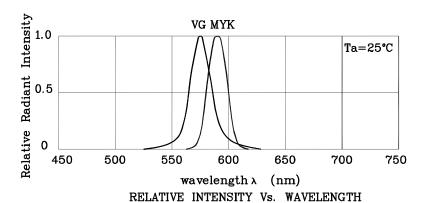
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I <sub>F</sub> =20mA) mcd		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZMYKVG56WT-5	XZMYKVG56WT-5 Yellow AlGaInP Water Clear	80	118	590	140°		
AZMTKVG96W1-9	Green	AlGaInP	water Clear	40	69	574	140

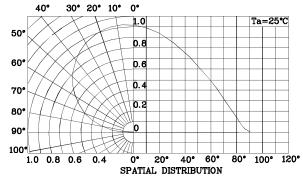
Apr 25,2011 XDSB4971 V2 Layout: Maggie L.

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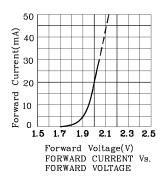
 $3.0 \mathrm{mmx} 1.0 \mathrm{mm}$  RIGHT ANGLE SMD CHIP LED LAMP

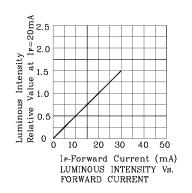


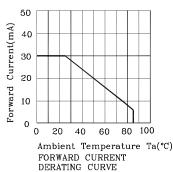


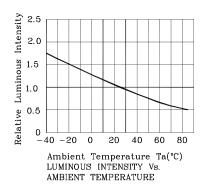


## **❖** MYK

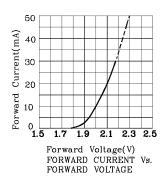


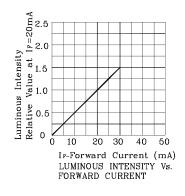


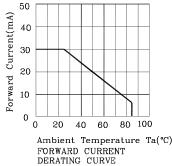


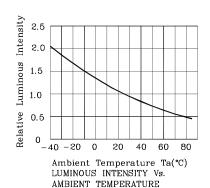


# ❖ VG







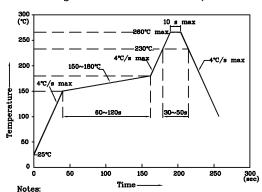


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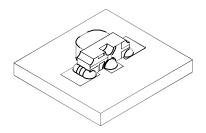
# LED is recommended for reflow soldering and soldering profile is shown below.

# Reflow Soldering Profile for SMD Products (Pb-Free Components)

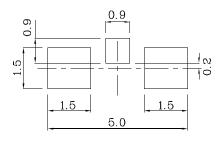


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- Do not put stress to the epoxy resin during high temperatures conditions

# ❖ The device has a single mounting surface. The device must be mounted according to the specifications.



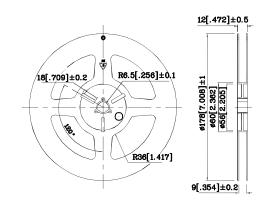
# **♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



# ❖ Tape Specification (Units:mm)

# TAPE 4.0±0.1 2.0±0.1 4.0±0.1 0.23±0.1 1.2±0.1 2 3

# **❖** Reel Dimension



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

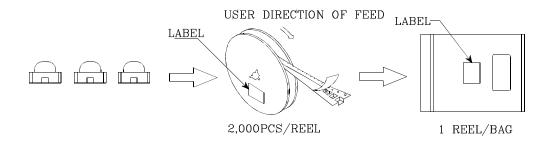
Note: Accuracy may depend on the sorting parameters.

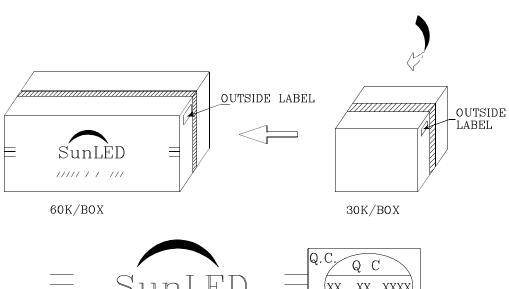
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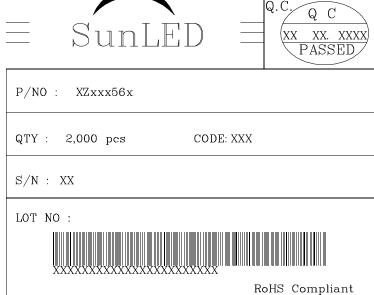


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# PACKING & LABEL SPECIFICATIONS







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